

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6184567

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SUNG-WEI SUN	06/30/2020
CHU-HSIEN CHOU	06/30/2020
YI-CHIH LIN	06/30/2020
PEI-CHUAN LEE	06/30/2020
WEN-HAO LIU	06/30/2020
RECEIVING PARTY DATA	
Name:	ASIA VITAL COMPONENTS CO., LTD.
Street Address:	7F.-3, NO. 24, WUCYUAN 2ND RD., SINJHUANG DISTRICT
City:	NEW TAIPEI CITY
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16920432
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	+886227090505
Email:	ip@tunhwa.com.tw
Correspondent Name:	ASIA VITAL COMPONENTS CO., LTD
Address Line 1:	7F, NO. 283, SEC 2, FUSHING S. RD.
Address Line 2:	DAAN DISTRICT
Address Line 4:	TAIPEI, TAIWAN 106
NAME OF SUBMITTER:	SUNG-WEI SUN
SIGNATURE:	/sung-wei sun/
DATE SIGNED:	07/03/2020
Total Attachments: 2	
source=assignment#page1.tif	
source=assignment#page2.tif	

ATTORNEY/DOCKET NO:

ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION

WHEREAS, I am the original, first and sole inventor and I own (if only one name is listed below) or an original, first and joint inventor and the joint inventors own (if plural names are listed below) (referred to as "ASSIGNOR" below) the subject matter which is claimed and for which a patent is sought on the invention (referred to as the "INVENTION" below) entitled:

Title: **FAN FRAME BODY STRUCTURE**

the specification of which (check one):

<input checked="" type="checkbox"/>	is executed on even date herewith.	
<input type="checkbox"/>	was filed on (day-month-year)	as U.S. Application Number
<input type="checkbox"/>	was filed on (day-month-year)	as PCT Application Number
<input type="checkbox"/>	was executed on the following date(s) (day-month-year)	

WHEREAS, **ASIA VITAL COMPONENTS CO., LTD.**

having a postal address of **7F.-3, No. 24, Wucyuan 2nd Rd., Sinjhuang District, New Taipei City, Taiwan (R.O.C.)**

(referred to as "ASSIGNEE" below) desires to acquire the entire right, title and interest in and to the same in the U.S.;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, ASSIGNOR, by these presents does sell, assign and transfer unto ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all patents granted on any division, continuation, continuation-in-part and reissue of said application.

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent applications in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the INVENTION that are within ASSIGNOR's possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR's obligations under this instrument shall extend to ASSIGNOR's heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all patents referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE's sole use and behoof; and for the use and behoof of ASSIGNEE's legal representatives and successors, to the full end of the term for which such patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

Full Name of First or Sole Inventor Sung-Wei Sun	Post Office Address 7F.-3, No. 24, Wucyuan 2nd Rd., Sinjhuang District, New Taipei City, Taiwan (R.O.C.)
Citizenship Taiwan (R.O.C.)	Residence (city, and either state or foreign country, MPEP §605.02) 7F.-3, No. 24, Wucyuan 2nd Rd., Sinjhuang District, New Taipei City, Taiwan (R.O.C.)
Date 2020.6.30	Signature <i>Sung Wei Sun</i>

See following page(s) for additional joint inventors.

Full Name of Second Inventor Chu-Hsien Chou	Post Office Address 7F.-3, No. 24, Wucyuan 2 nd Rd., Sinjhuang District, New Taipei City, Taiwan (R.O.C.)
Citizenship Taiwan (R.O.C.)	Residence (city, and either state or foreign country, MPEP §605.02) 7F.-3, No. 24, Wucyuan 2 nd Rd., Sinjhuang District, New Taipei City, Taiwan (R.O.C.)
Date 2020.6.30	Signature Chu-Hsien Chou

Full Name of Third Inventor Yi-Chih Lin	Post Office Address 7F.-3, No. 24, Wucyuan 2 nd Rd., Sinjhuang District, New Taipei City, Taiwan (R.O.C.)
Citizenship Taiwan (R.O.C.)	Residence (city, and either state or foreign country, MPEP §605.02) 7F.-3, No. 24, Wucyuan 2 nd Rd., Sinjhuang District, New Taipei City, Taiwan (R.O.C.)
Date 2020.6.30	Signature Yi-Chih Lin

Full Name of Fourth Inventor Pei-Chuan Lee	Post Office Address 7F.-3, No. 24, Wucyuan 2 nd Rd., Sinjhuang District, New Taipei City, Taiwan (R.O.C.)
Citizenship Taiwan (R.O.C.)	Residence (city, and either state or foreign country, MPEP §605.02) 7F.-3, No. 24, Wucyuan 2 nd Rd., Sinjhuang District, New Taipei City, Taiwan (R.O.C.)
Date 2020.6.30	Signature Pei Chuan Lee

Full Name of Fifth Inventor Wen-Hao Liu	Post Office Address 7F.-3, No. 24, Wucyuan 2 nd Rd., Sinjhuang District, New Taipei City, Taiwan (R.O.C.)
Citizenship Taiwan (R.O.C.)	Residence (city, and either state or foreign country, MPEP §605.02) 7F.-3, No. 24, Wucyuan 2 nd Rd., Sinjhuang District, New Taipei City, Taiwan (R.O.C.)
Date 2020.6.30	Signature Wen-Hao Liu